

# Quad 2-Channel Multiplexer

With 5 V-Tolerant Inputs

## MC74LVX157

The MC74LVX157 is an advanced high speed CMOS quad 2-channel multiplexer. The inputs tolerate voltages up to 5.5 V, allowing the interface of 5.0 V systems to 3.0 V systems.

It consists of four 2-input digital multiplexers with common select (S) and enable ( $\bar{E}$ ) inputs. When  $\bar{E}$  is held High, selection of data is inhibited and all the outputs go Low.

The select decoding determines whether the I0 n or I1 n inputs get routed to the corresponding Z n outputs.

### Features

- High Speed:  $t_{PD} = 5.1$  ns (Typ) at  $V_{CC} = 3.3$  V
- Low Power Dissipation:  $I_{CC} = 4$   $\mu$ A (Max) at  $T_A = 25$  °C
- Power Down Protection Provided on Inputs
- Balanced Propagation Delays
- Low Noise:  $V_{OLP} = 0.5$  V (Max)
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300 mA
- ESD Performance:  
Human Body Model > 2000 V
- These Devices are Pb-Free and are RoHS Compliant

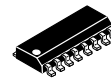
### PIN NAMES

| Pins      | Function             |
|-----------|----------------------|
| I0n       | Source 0 Data Inputs |
| I1n       | Source 1 Data Inputs |
| $\bar{E}$ | Enable Input         |
| S         | Select Input         |
| Zn        | Outputs              |

### TRUTH TABLE

| INPUTS    |   |     |     | OUTPUT |
|-----------|---|-----|-----|--------|
| $\bar{E}$ | S | I0n | I1n | Zn     |
| H         | X | X   | X   | L      |
| L         | H | X   | L   | L      |
| L         | H | X   | H   | H      |
| L         | L | L   | X   | L      |
| L         | L | H   | X   | H      |

H = High Voltage Level; L = Low Voltage Level; X = High or Low Voltage Level; For  $I_{CC}$  Reasons DO NOT FLOAT Inputs

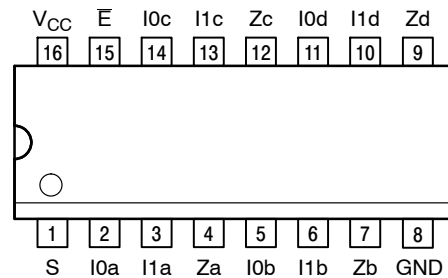


SOIC-16  
D SUFFIX  
CASE 751B



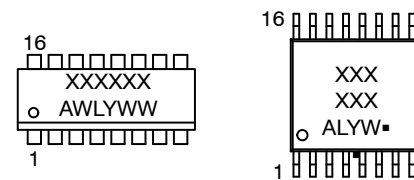
TSSOP-16  
DT SUFFIX  
CASE 948F

### PIN ASSIGNMENT



16-Lead (Top View)

### MARKING DIAGRAMS



SOIC-16

TSSOP-16

XXXXXX = Specific Device Code  
A = Assembly Location  
WL, L = Wafer Lot  
Y = Year  
WW, W = Work Week  
G or ■ = Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

## MC74LVX157

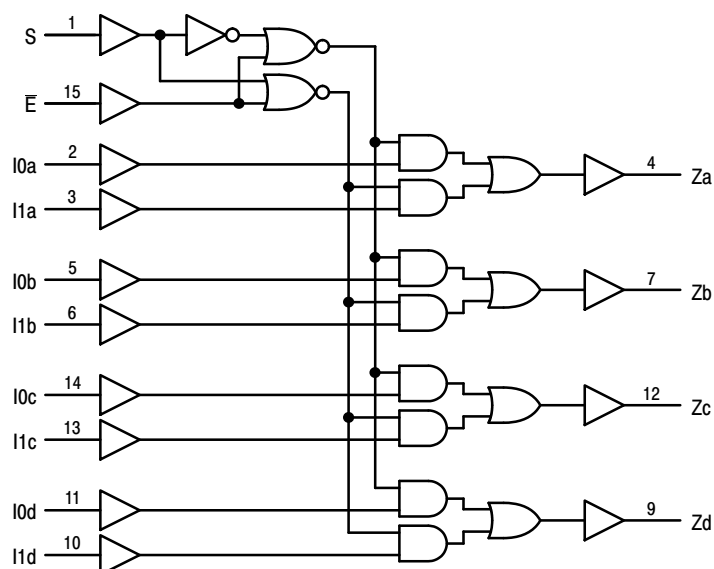


Figure 1. Logic Diagram

### MAXIMUM RATINGS

| Symbol           | Parameter                                       | Value                                    | Unit                 |      |
|------------------|-------------------------------------------------|------------------------------------------|----------------------|------|
| V <sub>CC</sub>  | DC Supply Voltage                               | −0.5 to +6.5                             | V                    |      |
| V <sub>IN</sub>  | DC Input Voltage                                | −0.5 to +6.5                             | V                    |      |
| V <sub>OUT</sub> | DC Output Voltage                               | −0.5 to V <sub>CC</sub> + 0.5            | V                    |      |
| I <sub>IN</sub>  | DC Input Current, per Pin                       | ±20                                      | mA                   |      |
| I <sub>OUT</sub> | DC Output Current, per Pin                      | ±25                                      | mA                   |      |
| I <sub>CC</sub>  | DC Supply Current, V <sub>CC</sub> and GND Pins | ±75                                      | mA                   |      |
| I <sub>IK</sub>  | Input Clamp Current                             | −20                                      | mA                   |      |
| I <sub>OK</sub>  | Output Clamp Current                            | ±20                                      | mA                   |      |
| T <sub>STG</sub> | Storage Temperature Range                       | −65 to +150                              | °C                   |      |
| T <sub>L</sub>   | Lead Temperature, 1 mm from Case for 10 Seconds | 260                                      | °C                   |      |
| T <sub>J</sub>   | Junction Temperature Under Bias                 | +150                                     | °C                   |      |
| θ <sub>JA</sub>  | Thermal Resistance (Note 1)                     | SOIC-16<br>TSSOP-16                      | 126<br>159           | °C/W |
| P <sub>D</sub>   | Power Dissipation in Still Air at 25 °C         | SOIC-16<br>TSSOP-16                      | 995<br>787           | mW   |
| MSL              | Moisture Sensitivity                            | Level 1                                  |                      |      |
| F <sub>R</sub>   | Flammability Rating                             | Oxygen Index: 28 to 34                   | UL 94 V-0 @ 0.125 in |      |
| V <sub>ESD</sub> | ESD Withstand Voltage (Note 2)                  | Human Body Model<br>Charged Device Model | 2000<br>N/A          | V    |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Measured with minimum pad spacing on an FR4 board, using 76mm-by-114mm, 2-ounce copper trace no air flow per JESD51-7.

2. HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

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## RECOMMENDED OPERATING CONDITIONS

| Symbol           | Parameter                                | Min | Max             | Unit |
|------------------|------------------------------------------|-----|-----------------|------|
| V <sub>CC</sub>  | DC Supply Voltage                        | 2.0 | 3.6             | V    |
| V <sub>in</sub>  | DC Input Voltage                         | 0   | 5.5             | V    |
| V <sub>out</sub> | DC Output Voltage                        | 0   | V <sub>CC</sub> | V    |
| T <sub>A</sub>   | Operating Temperature, All Package Types | -40 | +85             | °C   |
| Δt/ΔV            | Input Rise and Fall Time                 | 0   | 100             | ns/V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

## DC ELECTRICAL CHARACTERISTICS

| Symbol          | Parameter                                                                            | Test Conditions                                                                 | V <sub>CC</sub><br>V | T <sub>A</sub> = 25 °C |                 |                    | T <sub>A</sub> = -40 to 85 °C |                    | Unit |
|-----------------|--------------------------------------------------------------------------------------|---------------------------------------------------------------------------------|----------------------|------------------------|-----------------|--------------------|-------------------------------|--------------------|------|
|                 |                                                                                      |                                                                                 |                      | Min                    | Typ             | Max                | Min                           | Max                |      |
| V <sub>IH</sub> | High-Level Input Voltage                                                             |                                                                                 | 2.0<br>3.0<br>3.6    | 1.5<br>2.0<br>2.4      | –<br>–<br>–     | –<br>–<br>–        | 1.5<br>2.0<br>2.4             | –<br>–<br>–        | V    |
| V <sub>IL</sub> | Low-Level Input Voltage                                                              |                                                                                 | 2.0<br>3.0<br>3.6    | –<br>–<br>–            | –<br>–<br>–     | 0.5<br>0.8<br>0.8  | –<br>–<br>–                   | 0.5<br>0.8<br>0.8  | V    |
| V <sub>OH</sub> | High-Level Output Voltage<br>(V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub> ) | I <sub>OH</sub> = -50 μA<br>I <sub>OH</sub> = -50 μA<br>I <sub>OH</sub> = -4 mA | 2.0<br>3.0<br>3.0    | 1.9<br>2.9<br>2.58     | 2.0<br>3.0<br>– | –<br>–<br>–        | 1.9<br>2.9<br>2.48            | –<br>–<br>–        | V    |
| V <sub>OL</sub> | Low-Level Output Voltage<br>(V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub> )  | I <sub>OL</sub> = 50 μA<br>I <sub>OL</sub> = 50 μA<br>I <sub>OL</sub> = 4 mA    | 2.0<br>3.0<br>3.0    | –<br>–<br>–            | 0.0<br>0.0<br>– | 0.1<br>0.1<br>0.36 | –<br>–<br>–                   | 0.1<br>0.1<br>0.44 | V    |
| I <sub>in</sub> | Input Leakage Current                                                                | V <sub>in</sub> = 5.5 V or GND                                                  | 3.6                  | –                      | –               | ±0.1               | –                             | ±1.0               | μA   |
| I <sub>CC</sub> | Quiescent Supply Current                                                             | V <sub>in</sub> = V <sub>CC</sub> or GND                                        | 3.6                  | –                      | –               | 4.0                | –                             | 40.0               | μA   |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## AC ELECTRICAL CHARACTERISTICS (Input t<sub>r</sub> = t<sub>f</sub> = 3.0ns)

| Symbol                                   | Parameter                          | Test Conditions                                    | T <sub>A</sub> = 25 °C |      |      | T <sub>A</sub> = -40 to 85 °C |      | Unit |
|------------------------------------------|------------------------------------|----------------------------------------------------|------------------------|------|------|-------------------------------|------|------|
|                                          |                                    |                                                    | Min                    | Typ  | Max  | Min                           | Max  |      |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub>   | Propagation Delay, Input to Output | V <sub>CC</sub> = 2.7V C <sub>L</sub> = 15pF       | –                      | 6.6  | 12.5 | 1.0                           | 15.5 | ns   |
|                                          |                                    | C <sub>L</sub> = 50pF                              | –                      | 9.1  | 16.0 | 1.0                           | 19.0 |      |
|                                          |                                    | V <sub>CC</sub> = 3.3 ± 0.3V C <sub>L</sub> = 15pF | –                      | 5.1  | 7.9  | 1.0                           | 9.5  |      |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub>   | Propagation Delay, S to Zn         | C <sub>L</sub> = 50pF                              | –                      | 7.6  | 11.4 | 1.0                           | 13.0 | ns   |
|                                          |                                    | V <sub>CC</sub> = 2.7V C <sub>L</sub> = 15pF       | –                      | 8.9  | 16.9 | 1.0                           | 20.5 |      |
|                                          |                                    | C <sub>L</sub> = 50pF                              | –                      | 11.4 | 20.4 | 1.0                           | 24.0 |      |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub>   | Propagation Delay, $\bar{E}$ to Zn | V <sub>CC</sub> = 2.7V C <sub>L</sub> = 15pF       | –                      | 7.0  | 11.0 | 1.0                           | 13.0 | ns   |
|                                          |                                    | C <sub>L</sub> = 50pF                              | –                      | 9.5  | 14.5 | 1.0                           | 16.5 |      |
|                                          |                                    | V <sub>CC</sub> = 3.3 ± 0.3V C <sub>L</sub> = 15pF | –                      | 7.2  | 11.5 | 1.0                           | 13.5 |      |
| t <sub>OSSL</sub> ,<br>t <sub>OSLH</sub> | Output-to-Output Skew (Note 3)     | C <sub>L</sub> = 50pF                              | –                      | 9.7  | 15.0 | 1.0                           | 17.0 | ns   |
|                                          |                                    | V <sub>CC</sub> = 3.3 ± 0.3V C <sub>L</sub> = 50pF | –                      | –    | 1.5  | –                             | 1.5  |      |

3. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSSL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>); parameter guaranteed by design.

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## CAPACITIVE CHARACTERISTICS

| Symbol          | Parameter                              | T <sub>A</sub> = 25 °C |     |     | T <sub>A</sub> = -40 to 85 °C |     | Unit |
|-----------------|----------------------------------------|------------------------|-----|-----|-------------------------------|-----|------|
|                 |                                        | Min                    | Typ | Max | Min                           | Max |      |
| C <sub>in</sub> | Input Capacitance                      | –                      | 4   | 10  | –                             | 10  | pF   |
| C <sub>PD</sub> | Power Dissipation Capacitance (Note 4) | –                      | 20  | –   | –                             | –   | pF   |

4. C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:  $I_{CC(OPR)} = C_{PD} \cdot V_{CC} \cdot f_{in} + I_{CC}/4$  (per bit). C<sub>PD</sub> is used to determine the no-load dynamic power consumption;  $P_D = C_{PD} \cdot V_{CC}^2 \cdot f_{in} + I_{CC} \cdot V_{CC}$ .

## NOISE CHARACTERISTICS (Input t<sub>r</sub> = t<sub>f</sub> = 3.0ns, C<sub>L</sub> = 50pF, V<sub>CC</sub> = 3.3V, Measured in SOIC Package)

| Symbol           | Characteristic                               | T <sub>A</sub> = 25 °C |      | Unit |
|------------------|----------------------------------------------|------------------------|------|------|
|                  |                                              | Typ                    | Max  |      |
| V <sub>OLP</sub> | Quiet Output Maximum Dynamic V <sub>OL</sub> | 0.3                    | 0.5  | V    |
| V <sub>OLV</sub> | Quiet Output Minimum Dynamic V <sub>OL</sub> | –0.3                   | –0.5 | V    |
| V <sub>IHD</sub> | Minimum High Level Dynamic Input Voltage     | –                      | 2.0  | V    |
| V <sub>ILD</sub> | Maximum Low Level Dynamic Input Voltage      | –                      | 0.8  | V    |

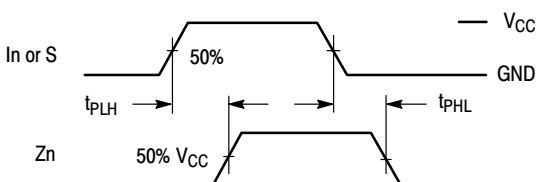


Figure 2.

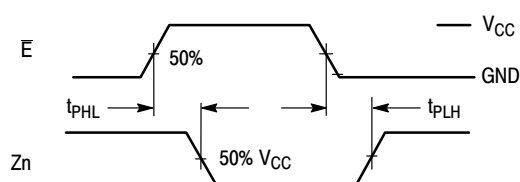


Figure 3.

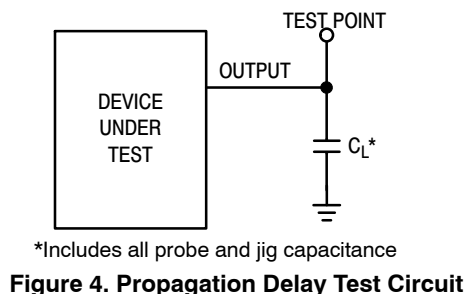


Figure 4. Propagation Delay Test Circuit

## ORDERING INFORMATION

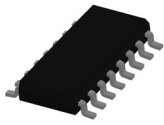
| Device          | Marking    | Package               | Shipping <sup>†</sup> |
|-----------------|------------|-----------------------|-----------------------|
| MC74LVX157DR2G  | LVX157G    | SOIC-16<br>(Pb-Free)  | 2500 Tape & Reel      |
| MC74LVX157DTR2G | LVX<br>157 | TSSOP-16<br>(Pb-Free) | 2500 Tape & Reel      |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

## MC74LVX157

### REVISION HISTORY

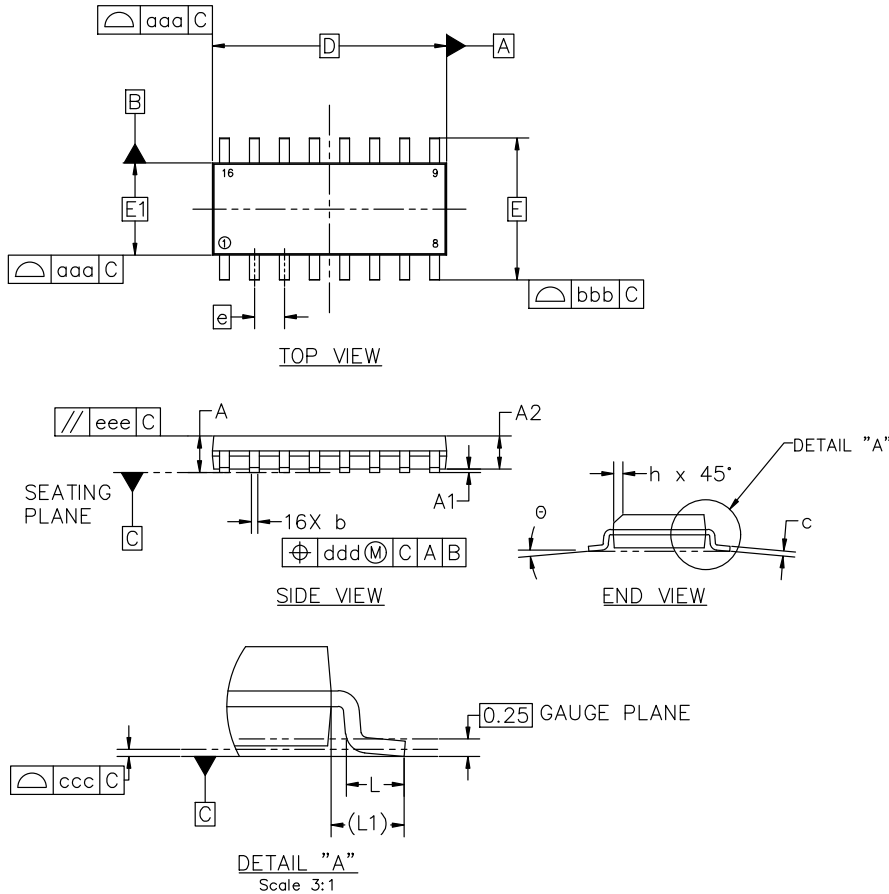
| Revision | Description of Changes                                                                                                                                                                                                                                                                                                                                     | Date       |
|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|
| 6        | Revision to change the value in the text (the inputs tolerate voltages) from 7.0 V to 5.5 V, replace the pictures of the marking Diagrams and remove "Machine Model > 200 V" from the Features on page 1, replace the Max. Rating table on page 2, add a new column to the Ordering Inf. table on page 4, add the revision history table on the last page. | 05/06/2024 |


**SOIC-16 9.90x3.90x1.37 1.27P**  
**CASE 751B**  
**ISSUE M**

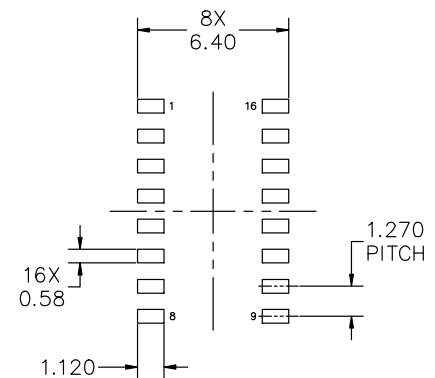
DATE 18 OCT 2024

## NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
2. DIMENSION IN MILLIMETERS. ANGLE IN DEGREES.
3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15mm PER SIDE.
5. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127mm TOTAL IN EXCESS OF THE b DIMENSION AT MAXIMUM MATERIAL CONDITION.



| MILLIMETERS                    |          |      |      |
|--------------------------------|----------|------|------|
| DIM                            | MIN      | NOM  | MAX  |
| A                              | 1.35     | 1.55 | 1.75 |
| A1                             | 0.10     | 0.18 | 0.25 |
| A2                             | 1.25     | 1.37 | 1.50 |
| b                              | 0.35     | 0.42 | 0.49 |
| c                              | 0.19     | 0.22 | 0.25 |
| D                              | 9.90 BSC |      |      |
| E                              | 6.00 BSC |      |      |
| E1                             | 3.90 BSC |      |      |
| e                              | 1.27 BSC |      |      |
| h                              | 0.25     | ---  | 0.50 |
| L                              | 0.40     | 0.83 | 1.25 |
| L1                             | 1.05 REF |      |      |
| θ                              | 0°       | ---  | 7°   |
| TOLERANCE OF FORM AND POSITION |          |      |      |
| aaa                            | 0.10     |      |      |
| bbb                            | 0.20     |      |      |
| ccc                            | 0.10     |      |      |
| ddd                            | 0.25     |      |      |
| eee                            | 0.10     |      |      |



\*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE onsemi SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERM/D

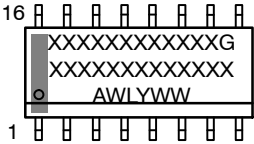
|                         |                                     |                                                                                                                                                                                  |
|-------------------------|-------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>DOCUMENT NUMBER:</b> | <b>98ASB42566B</b>                  | Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |
| <b>DESCRIPTION:</b>     | <b>SOIC-16 9.90X3.90X1.37 1.27P</b> | <b>PAGE 1 OF 2</b>                                                                                                                                                               |

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SOIC-16 9.90x3.90x1.37 1.27P  
CASE 751B  
ISSUE M

DATE 18 OCT 2024

GENERIC  
MARKING DIAGRAM\*

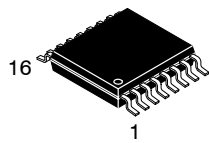


XXXXX = Specific Device Code  
A = Assembly Location  
WL = Wafer Lot  
Y = Year  
WW = Work Week  
G = Pb-Free Package

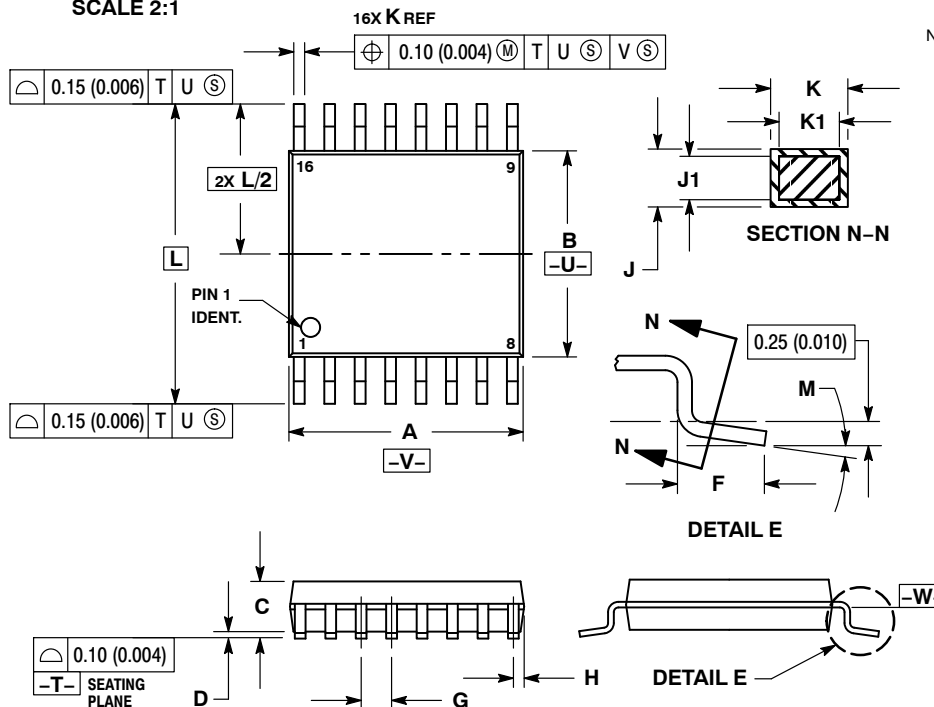
\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

|                                                                                                                                                                                                                                                                                         |                                                                                                                                                                                                                                                                     |                                                                                                                                                                                                                                                                                                                                                                                                                     |                                                                                                                                                                                                                                                                                                                             |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| STYLE 1:<br>PIN 1. COLLECTOR<br>2. BASE<br>3. EMITTER<br>4. NO CONNECTION<br>5. EMITTER<br>6. BASE<br>7. COLLECTOR<br>8. COLLECTOR<br>9. BASE<br>10. EMITTER<br>11. NO CONNECTION<br>12. EMITTER<br>13. BASE<br>14. COLLECTOR<br>15. EMITTER<br>16. COLLECTOR                           | STYLE 2:<br>PIN 1. CATHODE<br>2. ANODE<br>3. NO CONNECTION<br>4. CATHODE<br>5. CATHODE<br>6. NO CONNECTION<br>7. ANODE<br>8. CATHODE<br>9. CATHODE<br>10. ANODE<br>11. NO CONNECTION<br>12. CATHODE<br>13. CATHODE<br>14. NO CONNECTION<br>15. ANODE<br>16. CATHODE | STYLE 3:<br>PIN 1. COLLECTOR, DYE #1<br>2. BASE, #1<br>3. EMITTER, #1<br>4. COLLECTOR, #1<br>5. COLLECTOR, #2<br>6. BASE, #2<br>7. EMITTER, #2<br>8. COLLECTOR, #2<br>9. COLLECTOR, #3<br>10. BASE, #3<br>11. EMITTER, #3<br>12. COLLECTOR, #3<br>13. COLLECTOR, #4<br>14. BASE, #4<br>15. EMITTER, #4<br>16. COLLECTOR, #4                                                                                         | STYLE 4:<br>PIN 1. COLLECTOR, DYE #1<br>2. COLLECTOR, #1<br>3. COLLECTOR, #2<br>4. COLLECTOR, #2<br>5. COLLECTOR, #3<br>6. COLLECTOR, #3<br>7. COLLECTOR, #4<br>8. COLLECTOR, #4<br>9. BASE, #4<br>10. EMITTER, #4<br>11. BASE, #3<br>12. EMITTER, #3<br>13. BASE, #2<br>14. EMITTER, #2<br>15. BASE, #1<br>16. EMITTER, #1 |
| STYLE 5:<br>PIN 1. DRAIN, DYE #1<br>2. DRAIN, #1<br>3. DRAIN, #2<br>4. DRAIN, #2<br>5. DRAIN, #3<br>6. DRAIN, #3<br>7. DRAIN, #4<br>8. DRAIN, #4<br>9. GATE, #4<br>10. SOURCE, #4<br>11. GATE, #3<br>12. SOURCE, #3<br>13. GATE, #2<br>14. SOURCE, #2<br>15. GATE, #1<br>16. SOURCE, #1 | STYLE 6:<br>PIN 1. CATHODE<br>2. CATHODE<br>3. CATHODE<br>4. CATHODE<br>5. CATHODE<br>6. CATHODE<br>7. CATHODE<br>8. CATHODE<br>9. ANODE<br>10. ANODE<br>11. ANODE<br>12. ANODE<br>13. ANODE<br>14. ANODE<br>15. ANODE<br>16. ANODE                                 | STYLE 7:<br>PIN 1. SOURCE N-CH<br>2. COMMON DRAIN (OUTPUT)<br>3. COMMON DRAIN (OUTPUT)<br>4. GATE P-CH<br>5. COMMON DRAIN (OUTPUT)<br>6. COMMON DRAIN (OUTPUT)<br>7. COMMON DRAIN (OUTPUT)<br>8. SOURCE P-CH<br>9. SOURCE P-CH<br>10. COMMON DRAIN (OUTPUT)<br>11. COMMON DRAIN (OUTPUT)<br>12. COMMON DRAIN (OUTPUT)<br>13. GATE N-CH<br>14. COMMON DRAIN (OUTPUT)<br>15. COMMON DRAIN (OUTPUT)<br>16. SOURCE N-CH |                                                                                                                                                                                                                                                                                                                             |

|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |                              |                                                                                                                                                                                     |
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| DESCRIPTION:                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | SOIC-16 9.90X3.90X1.37 1.27P | PAGE 2 OF 2                                                                                                                                                                         |
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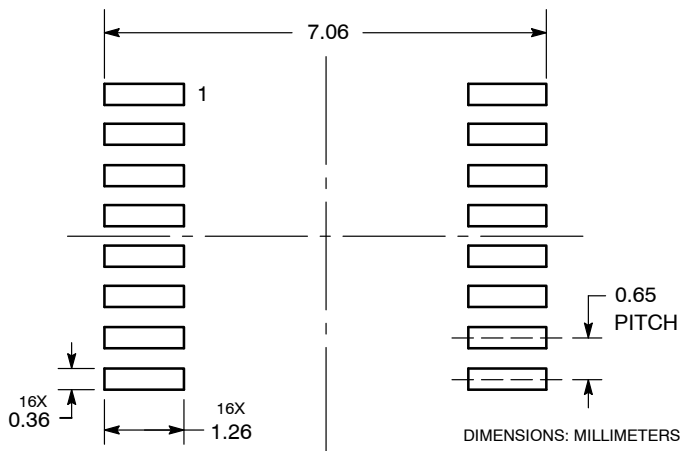

**TSSOP-16 WB**  
**CASE 948F**  
**ISSUE B**

DATE 19 OCT 2006

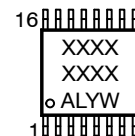

**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 4.90        | 5.10 | 0.193     | 0.200 |
| B   | 4.30        | 4.50 | 0.169     | 0.177 |
| C   | ---         | 1.20 | ---       | 0.047 |
| D   | 0.05        | 0.15 | 0.002     | 0.006 |
| F   | 0.50        | 0.75 | 0.020     | 0.030 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| H   | 0.18        | 0.28 | 0.007     | 0.011 |
| J   | 0.09        | 0.20 | 0.004     | 0.008 |
| J1  | 0.09        | 0.16 | 0.004     | 0.006 |
| K   | 0.19        | 0.30 | 0.007     | 0.012 |
| K1  | 0.19        | 0.25 | 0.007     | 0.010 |
| L   | 6.40 BSC    |      | 0.252 BSC |       |
| M   | 0°          | 8°   | 0°        | 8°    |

**RECOMMENDED  
SOLDERING FOOTPRINT\***


\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

**GENERIC  
MARKING DIAGRAM\***


XXXX = Specific Device Code  
A = Assembly Location  
L = Wafer Lot  
Y = Year  
W = Work Week  
G or ■ = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

|                         |                    |                                                                                                                                                                                  |
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| <b>DESCRIPTION:</b>     | <b>TSSOP-16</b>    | <b>PAGE 1 OF 1</b>                                                                                                                                                               |

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